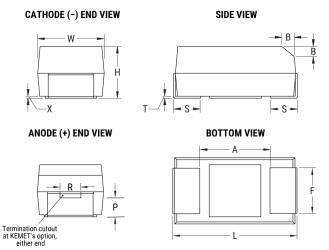


## T591B225M035ATE200

T591, Tantalum, Polymer Tantalum, 2.2 uF, 20%, 35 VDC, SMD, Polymer, Molded, Low ESR, 200 mOhms, 3528, Height Max = 2.1mm



Click	here	for	the	3D	model.
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Dimensions	
Footprint	3528
L	3.5mm +/-0.2mm
W	2.8mm +/-0.2mm
Н	1.9mm +/-0.2mm
Т	0.13mm REF
S	0.8mm +/-0.3mm
F	2.2mm +/-0.1mm
Α	1.1mm MIN
В	0.4mm +/-0.15mm
Р	0.5mm REF
R	1mm REF
Χ	0.1mm +/-0.1mm

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	2000

Concrelinformation	
General Information	
Series	T591
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Low ESR
Features	Automotive
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200 (Limited 500 Hrs 85C/85% RH/Ur)
AEC-Q200	Subject to PPAP/PSW and change control
Component Weight	94.9 mg
Shelf Life	52 Weeks
MSL	3

Specifications	
Capacitance	2.2 uF
Capacitance Tolerance	20%
Voltage DC	35 VDC (105C), 23.45 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	105°C
Humidity	85C, 85% RH, load, 500 Hours
Dissipation Factor	8% 120Hz 25C
Failure Rate	N/A
Resistance	200 mOhms (100kHz 25C)
Ripple Current	820 mA (rms, 100kHz 45C), 574 mA (rms, 105C), 205 mA (rms, 125C)
Leakage Current	7.7 uA (5min 25°C)

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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